

Spread Spectrum Clock Generator

MB88155 is a clock generator for EMI (Electro Magnetic Interference) reduction. The peak of unnecessary radiation noise (EMI) can be attenuated by making the oscillation frequency slightly modulate periodically with the internal modulator. For modulation, the MB88155 supports both center-spreading and down-spreading. It has a non-modulated clock output pin (REFOUT) as well as a modulated clock output pin (CKOUT).

Features

- Input frequency : 12.5 MHz to 50 MHz (Multiplied by 1)
12.5 MHz to 20 MHz (Multiplied by 4)
- Output frequency : CKOUT 12.5 MHz to 80 MHz
REFOUT The same as input frequency (not multiplied)
- Modulation rate : $\pm 0.5\%$, $\pm 1.0\%$ (center spread), $- 1.0\%$, $- 2.0\%$ (Down spread)
- Equipped with oscillation circuit : range of oscillation 12.5 MHz to 40 MHz (Fundamental oscillation)
40 MHz to 48 MHz (3rd overtone)
- Modulation clock output Duty : 40% to 60%
- Modulation clock cycle – cycle jitter :

MB88155-1xx	12.5 MHz to 20 MHz	less than 150 ps
MB88155-1xx	20 MHz to 50 MHz	less than 100 ps
MB88155-4xx		less than 200 ps
- Low current consumption by CMOS process : 5 mA (24 MHz : Typ-sample, no load)
- Power supply voltage : 3.3 V \pm 0.3 V
- Operating temperature : $- 40\text{ }^{\circ}\text{C}$ to $+ 85\text{ }^{\circ}\text{C}$
- Package : 8-pin plastic TSSOP

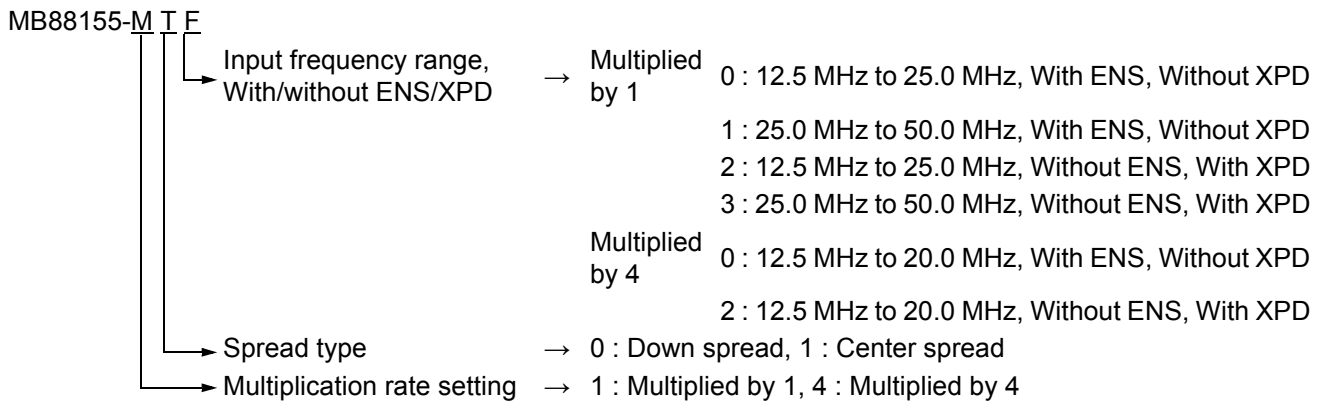
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1. Product Lineup

The MB88155 is available in different models : 2 models different in multiplier ($\times 1$ and $\times 4$), 2 in modulation type (center-spreading and down-spreading), 2 in input frequency range at a multiplier of 1 (12.5 MHz to 25 MHz and 25 MHz to 50 MHz), and 1 in input frequency range at a multiplier of 4 (12.5 MHz to 20 MHz).

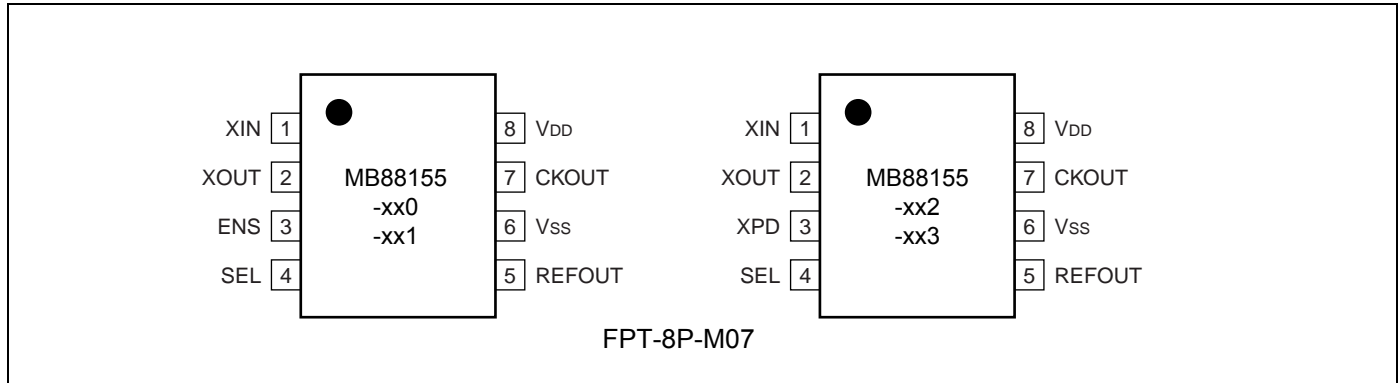
The MB88155 is also available in two versions : modulation-on/off selectable version (with ENS pin) and power-down function built-in version (with XPD pin).



Line-up of MB88155

Product	Input frequency	Multiplication rate	Output frequency	Modulation type	Modulation enable pin	Powerdown pin		
MB88155-100	12.5 MHz to 25 MHz	Multiplied by 1	The same as input frequency	Down spread	Yes	No		
MB88155-101	25 MHz to 50 MHz				No	Yes		
MB88155-102	12.5 MHz to 25 MHz				Center spread	Yes	No	
MB88155-103	25 MHz to 50 MHz					No	Yes	
MB88155-110	12.5 MHz to 25 MHz			Multiplied by 4	50 MHz to 80 MHz	Down spread	Yes	No
MB88155-111	25 MHz to 50 MHz						No	Yes
MB88155-112	12.5 MHz to 25 MHz					Center spread	Yes	No
MB88155-113	25 MHz to 50 MHz						No	Yes

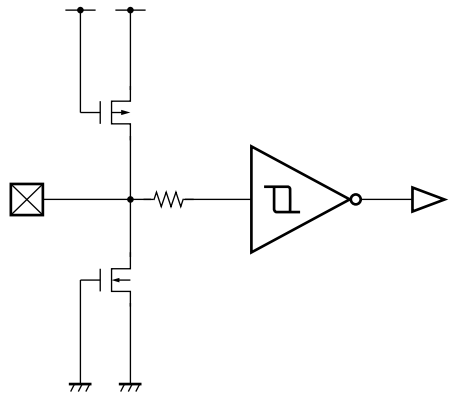
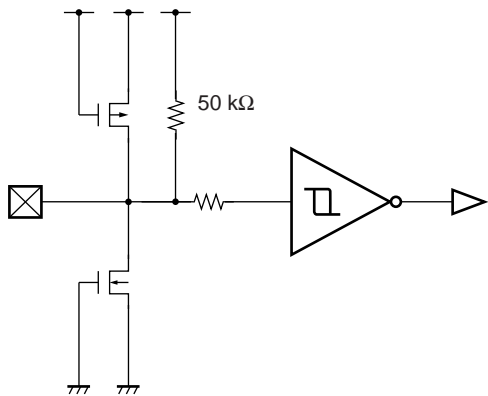
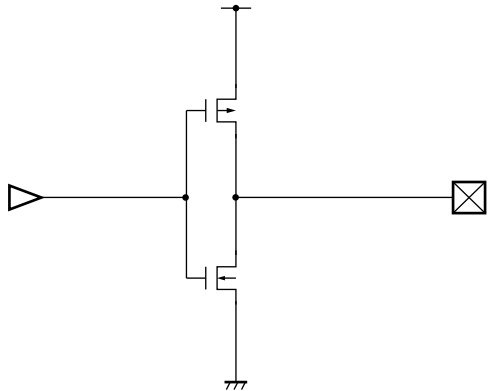
2. Pin Assignment



3. Pin Description

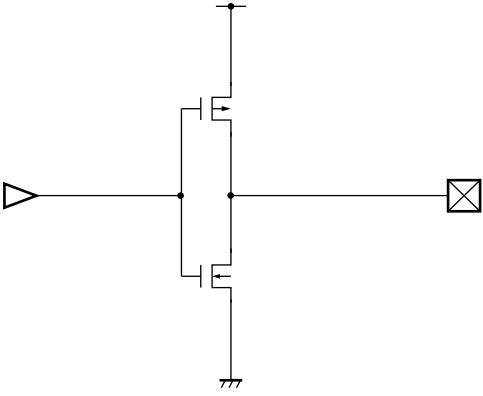
Pin name	I/O	Pin no.	Description
XIN	I	1	Connection pin of resonator/clock input pin
XOUT	O	2	Connection pin of resonator
ENS/XPD	I	3	Modulation enable pin/power down pin
SEL	I	4	Modulation rate setting pin Down spread, SEL = "L" : Modulation rate – 1.0% Down spread, SEL = "H" : Modulation rate – 2.0% Down spread, SEL = "L" : Modulation rate ± 0.5% Down spread, SEL = "H" : Modulation rate ± 1.0%
REFOUT	O	5	Non-modulated clock output pin This pin becomes to "L" at power-down.
V _{SS}	—	6	GND Pin
CKOUT	O	7	Modulated clock output pin This pin becomes to "L" at power-down.
V _{DD}	—	8	Power supply voltage pin

4. I/O Circuit Type

Pin	Circuit type	Remarks
SEL, XPD		CMOS hysteresis input
ENS		CMOS hysteresis input with pull-up resistor of 50 kΩ (Typ)
REFOUT		<ul style="list-style-type: none"> ■ CMOS output ■ $I_{OL} = 3 \text{ mA}$ ■ "L" output at power-down

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Pin	Circuit type	Remarks
CKOUT	 <p>The diagram shows a CMOS output stage. An inverter's output is connected to the gate of an nMOSFET. The nMOSFET's source is grounded, and its drain is connected to a pMOSFET's drain. The pMOSFET's gate is connected to the inverter's input, and its source is connected to a pull-up resistor leading to VDD. The output node, between the two MOSFETs, is connected to a load resistor leading to a square symbol representing a load.</p>	<ul style="list-style-type: none"> ■ CMOS output ■ $I_{OL} = 4 \text{ mA}$ ■ "L" output at power-down

Note : For XIN pin and XOUT pin, refer to "Oscillation Circuit".

5. Handling Devices

5.1 Preventing Latch-up

A latch-up can occur if, on this device, (a) a voltage higher than V_{DD} or a voltage lower than V_{SS} is applied to an input or output pin or (b) a voltage higher than the rating is applied between V_{DD} and V_{SS} . The latch-up, if it occurs, significantly increases the power supply current and may cause thermal destruction of an element. When you use this device, be very careful not to exceed the maximum rating.

5.2 Handling unused pins

Do not leave an unused input pin open, since it may cause a malfunction. Handle by, using a pull-up or pull-down resistor. Unused output pin should be opened.

5.3 The attention when the external clock is used

Input the clock to XIN pin, and XOUT pin should be opened when you use the external clock. Please pay attention so that an overshoot and an undershoot do not occur to an input clock of XIN pin.

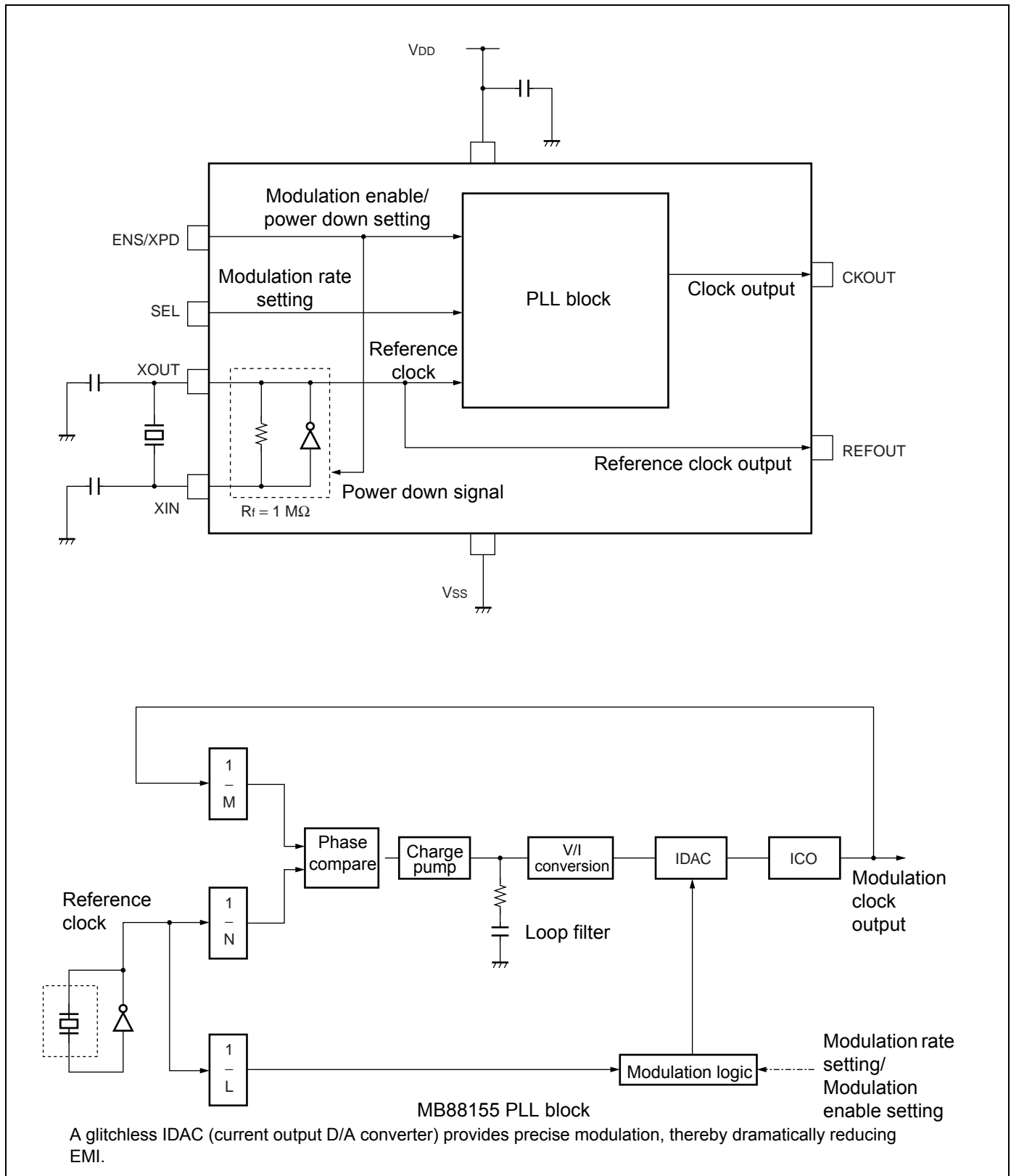
5.4 Power supply pins

Please design connecting the power supply pin of this device by as low impedance as possible from the current supply source. We recommend connecting electrolytic capacitor (about 10 μF) and the ceramic capacitor (about 0.01 μF) in parallel between V_{SS} and V_{DD} near the device, as a bypass capacitor.

5.5 Oscillation circuit

Noise near the XIN and XOUT pins may cause the device to malfunction. Design printed circuit boards so that electric wiring of XIN or XOUT pin and the resonator do not intersect other wiring. Design the printed circuit board that surrounds the XIN and XOUT pins with ground.

6. Block Diagram



7. Pin Setting

The modulation clock requires stabilization wait time after the PIN setting is changed. For the modulation clock stabilization wait time, assure the maximum value for “Lock-up time” in the AC Characteristics list in “[Electrical Characteristics](#)”.

ENS modulation enable setting

ENS	Modulation	
L	No modulation	MB88155-xx0, xx1
H	Modulation	

Note : Spectrum does not diffuse when “L” is set to ENS pin.
 MB88155-xx2, xx3 do not have ENS pin.

XPD power down

XPD	Status	
L	Power down status	MB88155-xx2, xx3
H	Operating status	

Note : When setting “L” to XPD pin, it becomes power down mode (low power consumption mode) .
 Both CKOUT and REFOUT of output pins are fixed to “L” output during power down.
 MB88155-xx0, xx1 do not have XPD pin.

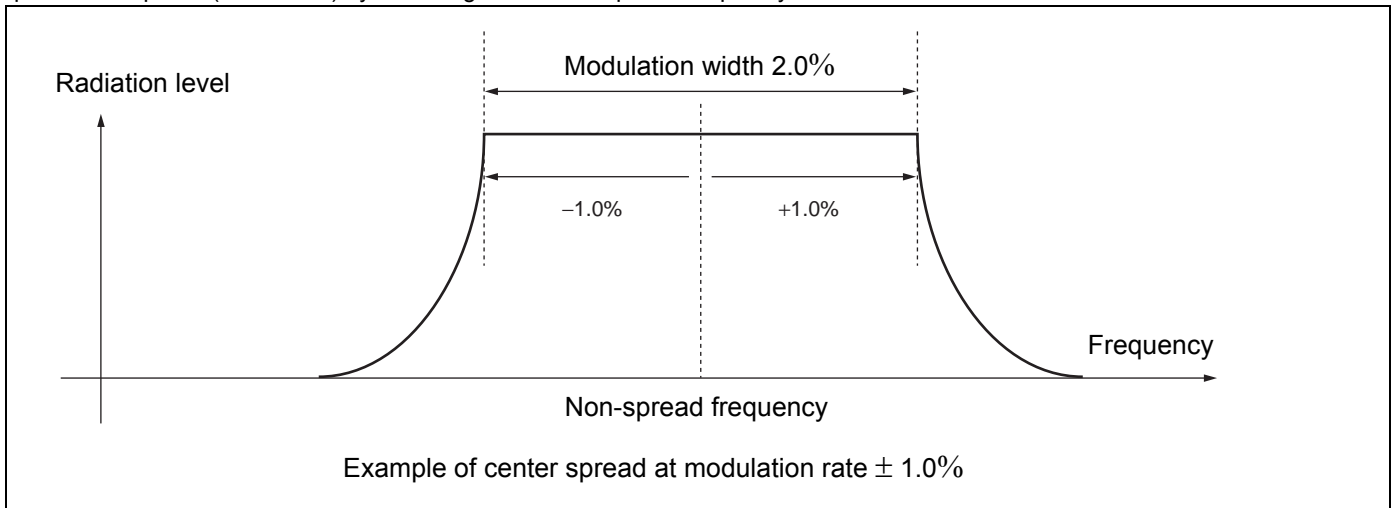
SEL modulation rate setting

SEL	Frequency	
L	± 0.5%	MB88155-x1x
	- 1.0%	MB88155-x0x
H	± 1.0%	MB88155-x1x
	- 2.0%	MB88155-x0x

Note : The modulation rate can be changed at the level of the pin.

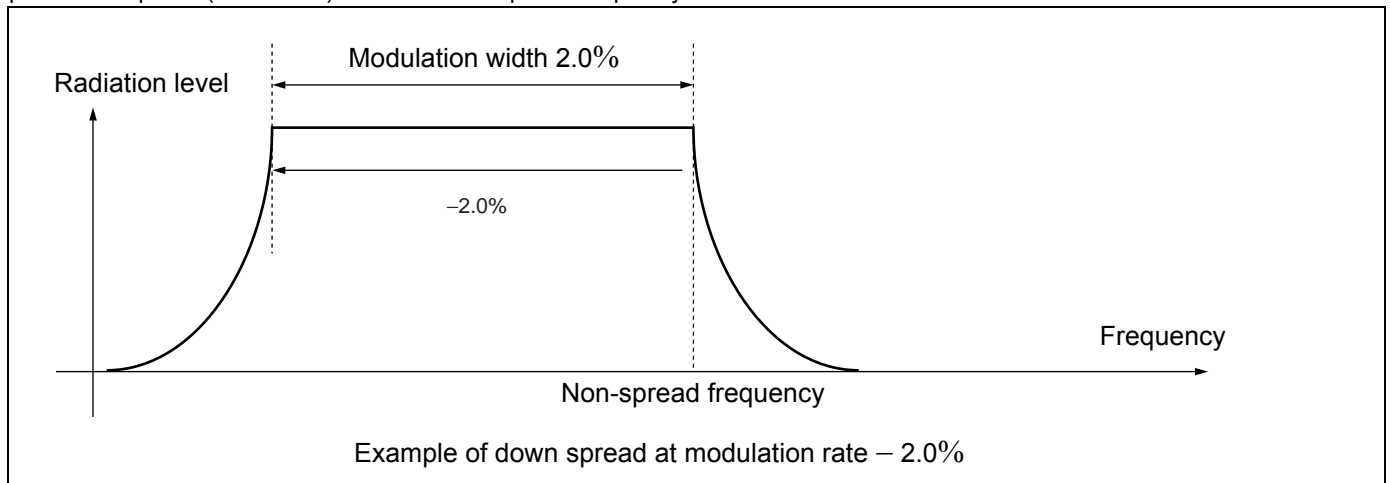
■ Center spread

Spectrum is spread (modulated) by centering on the non-spread frequency.



■ Down spread

Spectrum is spread (modulated) below the non-spread frequency.

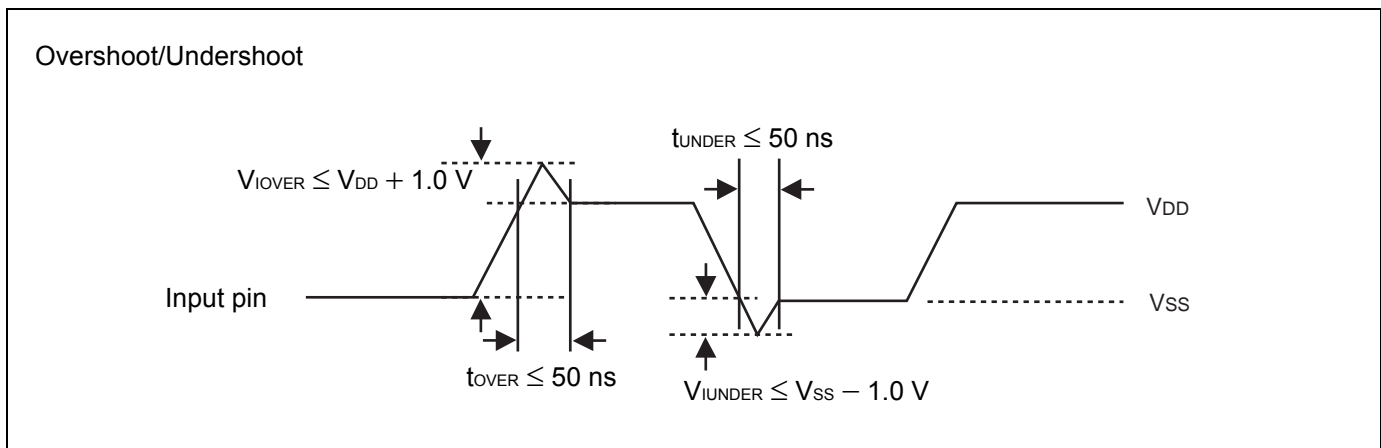


8. Absolute Maximum Ratings

Parameter	Symbol	Rating		Unit
		Min	Max	
Power supply voltage*	V_{DD}	- 0.5	+ 4.0	V
Input voltage*	V_I	$V_{SS} - 0.5$	$V_{DD} + 0.5$	V
Output voltage*	V_O	$V_{SS} - 0.5$	$V_{DD} + 0.5$	V
Storage temperature	T_{ST}	- 55	+ 125	°C
Operation junction temperature	T_J	- 40	+ 125	°C
Output current	I_O	- 14	+ 14	mA
Overshoot	V_{IOVER}	—	$V_{DD} + 1.0$ ($t_{OVER} \leq 50$ ns)	V
Undershoot	V_{IUNDER}	$V_{SS} - 1.0$ ($t_{UNDER} \leq 50$ ns)	—	V

* : The parameter is based on $V_{SS} = 0.0$ V.

WARNING: Semiconductor devices can be permanently damaged by application of stress (voltage, current, temperature, etc.) in excess of absolute maximum ratings. Do not exceed these ratings.



9. Recommended Operating Conditions

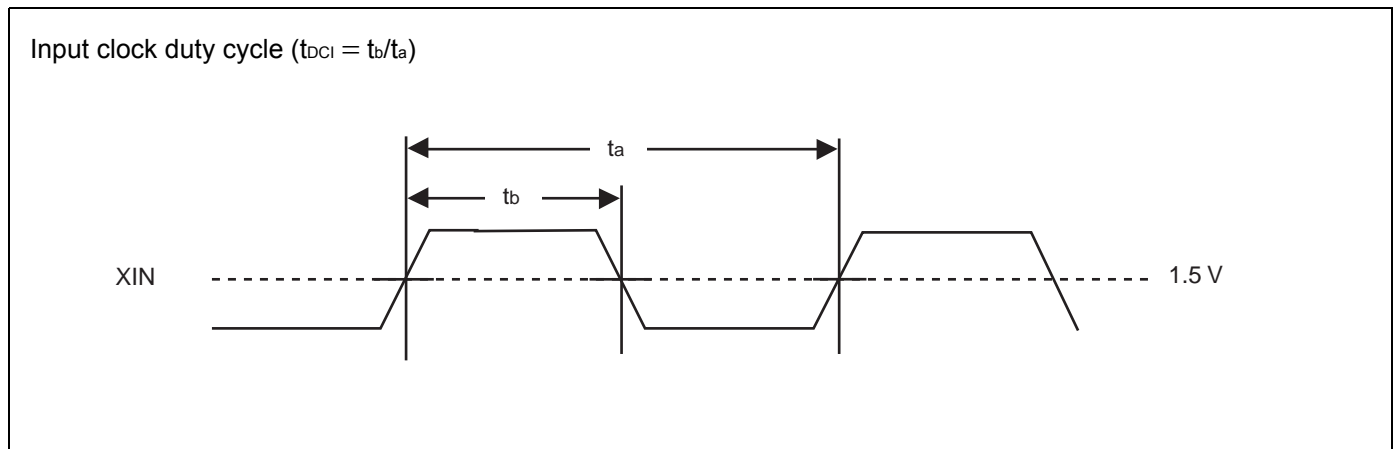
(V_{SS} = 0.0 V)

Parameter	Symbol	Pin	Conditions	Value			Unit
				Min	Typ	Max	
Power supply voltage	V _{DD}	V _{DD}	—	3.0	3.3	3.6	V
“H” level input voltage	V _{IH}	XIN, SEL, ENS, XPD	—	V _{DD} × 0.8	—	V _{DD} + 0.3	V
“L” level input voltage	V _{IL}	XIN, SEL, ENS, XPD	—	V _{SS}	—	V _{DD} × 0.2	V
Input clock duty cycle	t _{DCI}	XIN	12.5 MHz to 50 MHz	40	50	60	%
Operating temperature	T _a	—	—	- 40	—	+ 85	°C

WARNING: The recommended operating conditions are required in order to ensure the normal operation of the semiconductor device. All of the device’s electrical characteristics are warranted when the device is operated within these ranges.

Always use semiconductor devices within their recommended operating condition ranges. Operation outside these ranges may adversely affect reliability and could result in device failure.

No warranty is made with respect to uses, operating conditions, or combinations not represented on the data sheet. Users considering application outside the listed conditions are advised to contact their Cypress representatives beforehand.



10. Electrical Characteristics

■ DC Characteristics

($T_a = -40\text{ }^{\circ}\text{C}$ to $+85\text{ }^{\circ}\text{C}$, $V_{DD} = 3.3\text{ V} \pm 0.3\text{ V}$, $V_{SS} = 0.0\text{ V}$)

Parameter	Symbol	Pin	Conditions	Value			Unit
				Min	Typ	Max	
Power supply current	I_{CC}	V_{DD}	24 MHz output No load capacitance	—	5.0	7.0	mA
			At power-down	—	10	—	μA
Output voltage	V_{OHC}	CKOUT	“H” level output $I_{OH} = -4\text{ mA}$	$V_{DD} - 0.5$	—	V_{DD}	V
	V_{OHR}	REFOUT	“H” level output $I_{OH} = -3\text{ mA}$				
	V_{OLC}	CKOUT	“L” level output $I_{OL} = 4\text{ mA}$	V_{SS}	—	0.4	V
	V_{OLR}	REFOUT	“L” level output $I_{OL} = 3\text{ mA}$				
Output impedance	Z_{OC}	CKOUT	12.5 MHz to 80 MHz	—	45	—	Ω
	Z_{OR}	REFOUT	12.5 MHz to 50 MHz	—	70	—	
Input capacitance	C_{IN}	XIN, SEL, ENS/XPD	$T_a = +25\text{ }^{\circ}\text{C}$ $V_{DD} = V_I = 0.0\text{ V}$ $f = 1\text{ MHz}$	—	—	16	pF
Input pull-up resistor	R_{PU}	ENS	$V_{IL} = 0.0\text{ V}$	25	50	200	$k\Omega$
Load capacitance	C_L	REFOUT	12.5 MHz to 50 MHz	—	—	15	pF
		CKOUT	12.5 MHz to 50 MHz	—	—	15	
			50 MHz to 80 MHz	—	—	7	

■ AC Characteristics

 (Ta = -40 °C to +85 °C, V_{DD} = 3.3 V ± 0.3 V, V_{SS} = 0.0 V)

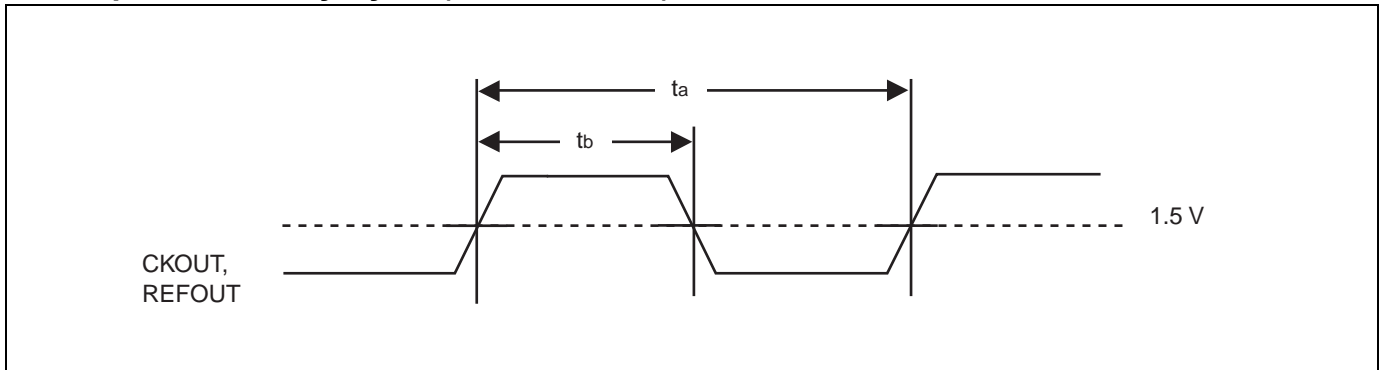
Parameter	Symbol	Pin	Conditions	Value			Unit
				Min	Typ	Max	
Oscillation frequency	f _x	XIN, XOUT	Fundamental oscillation	12.5	—	40	MHz
			3 rd overtone	40	—	48	
Input frequency	f _{in}	XIN	MB88155 – 1x0, 1x2	12.5	—	25	MHz
			MB88155 – 1x1, 1x3	25	—	50	
			MB88155 – 4xx	12.5	—	20	
Output frequency	f _{OUT}	REFOUT	MB88155 – 1x0, 1x2	12.5	—	25	MHz
			MB88155 – 1x1, 1x3	25	—	50	
			MB88155 – 4xx	12.5	—	20	
		CKOUT	MB88155 – 1x0, 1x2	12.5	—	25	
			MB88155 – 1x1, 1x3	25	—	50	
			MB88155 – 4xx	50	—	80	
Output slew rate	SR _C	CKOUT	Load capacitance 15 pF, 0.4 V to 2.4 V	0.4	—	4.0	V/ns
	SR _R	REFOUT	Load capacitance 15 pF, 0.4 V to 2.4 V	0.3	—	2.0	
Output clock duty cycle	t _{DCC}	CKOUT	1.5 V reference level	40	—	60	%
	t _{DCR}	REFOUT	1.5 V reference level	t _{dci} – 10*1	—	t _{dci} + 10*1	
Modulation frequency	f _{MOD}	CKOUT	Input frequency at 24 MHz	—	32.4	—	kHz
Lock-up time*2	t _{LK}	CKOUT	—	—	2	5	ms
Cycle-cycle jitter	t _{IC}	CKOUT	MB88155 – 1xx Input frequency 12.5 MHz to 20 MHz, No load capacitance, Ta = +25 °C, V _{DD} = 3.3 V, Standard deviation σ	—	—	150	ps
			MB88155 – 1xx Input frequency 20 MHz to 50 MHz, No load capacitance, Ta = +25 °C, V _{DD} = 3.3 V, Standard deviation σ	—	—	100	
			MB88155 – 4xx No load capacitance, Ta = +25 °C, V _{DD} = 3.3 V, Stan- dard deviation σ	—	—	200	

*1 : Duty of the REFOUT output is guaranteed only for the following A and B because it depends on t_{dci} of input clock duty.

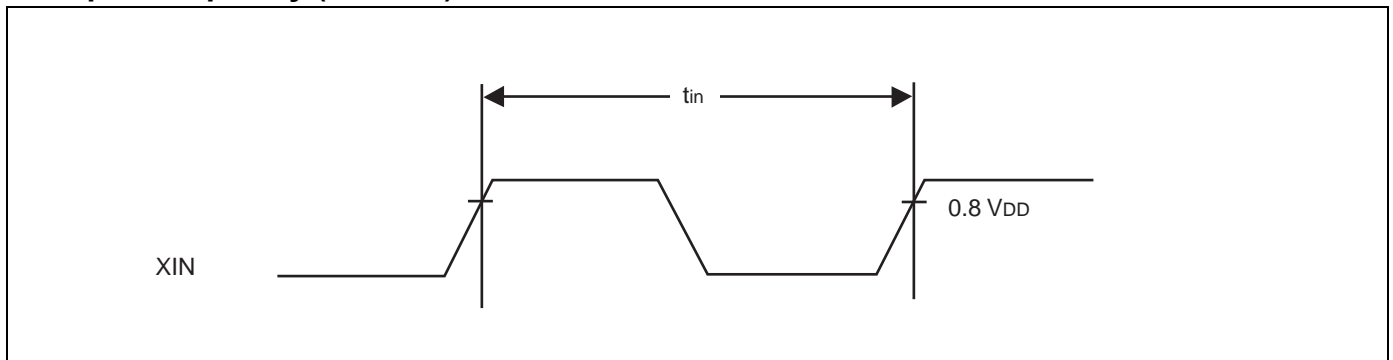
- A. Resonator input : When resonator is connected with XIN pin and XOUT pin, and oscillates normally.
- B. External clock input : The input level is Full-swing (V_{SS} – V_{DD}).

*2 : The modulation clock requires stabilization wait time after the IC is turned on or released from power-down mode, or after SEL (modulation factor) or ENS (modulation enable) setting is changed. For the modulation clock stabilization wait time, assure the maximum value for the lock-up time.

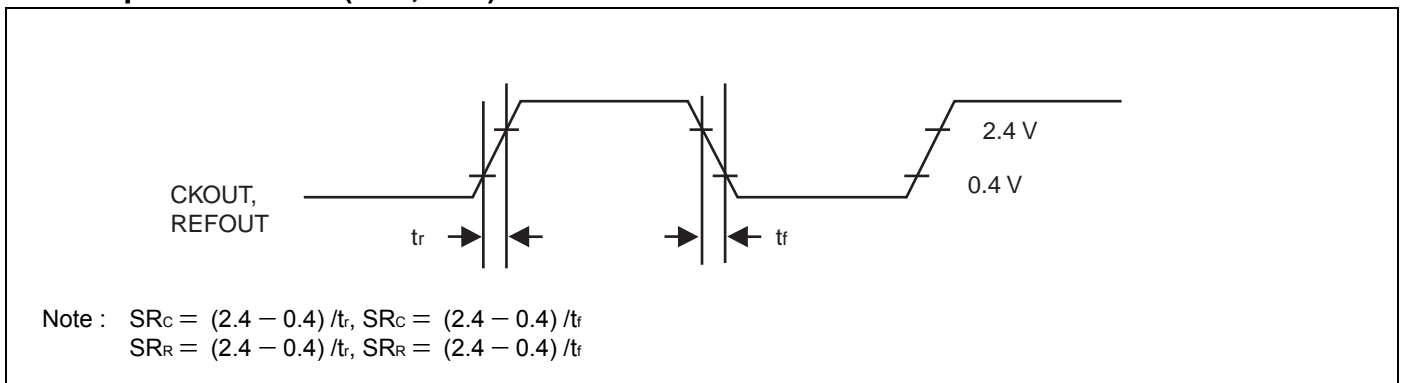
11. Output Clock Duty Cycle (t_{DCC} , $t_{DCR} = t_b/t_a$)



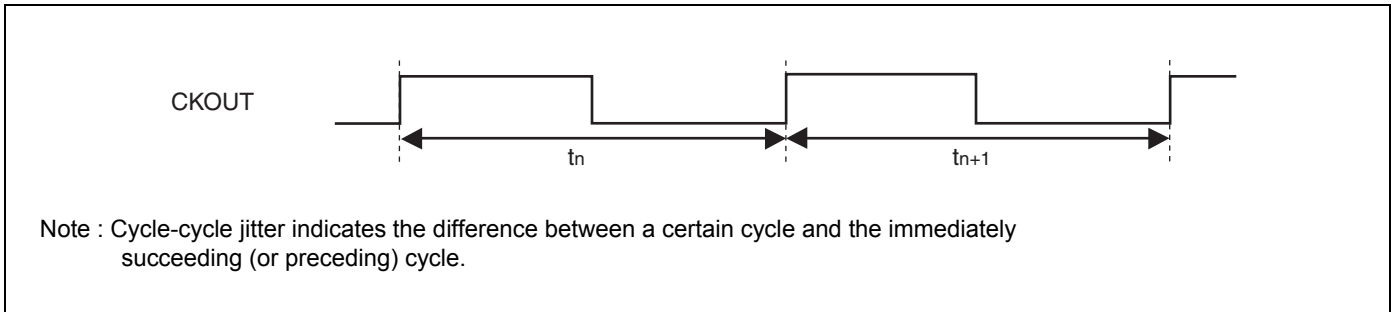
12. Input Frequency ($f_{in} = 1/t_{in}$)



13. Output Slew Rate (SR_C , SR_R)

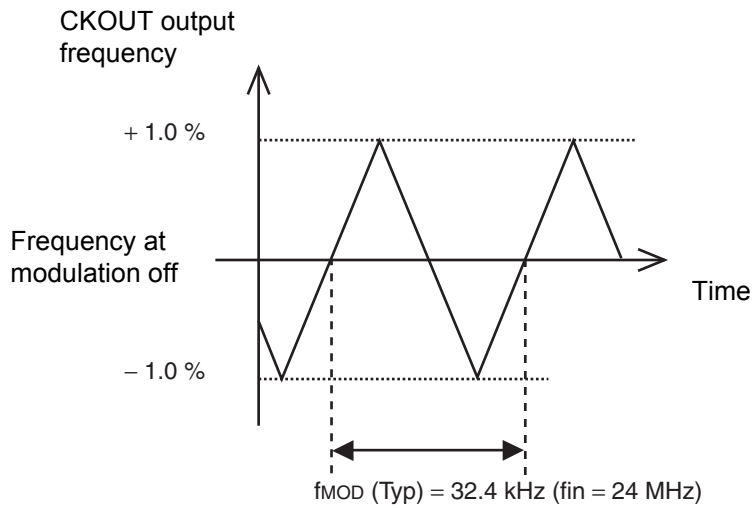


14. Cycle-Cycle Jitter ($t_{JC} = |t_n - t_{n+1}|$)

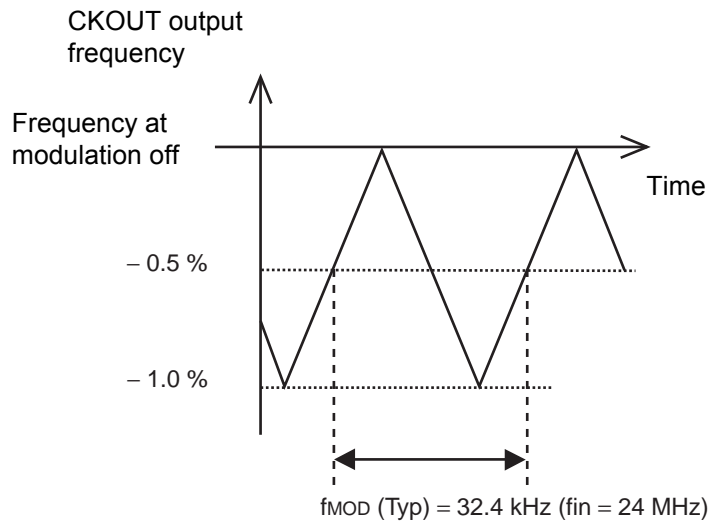


15. Modulation Waveform

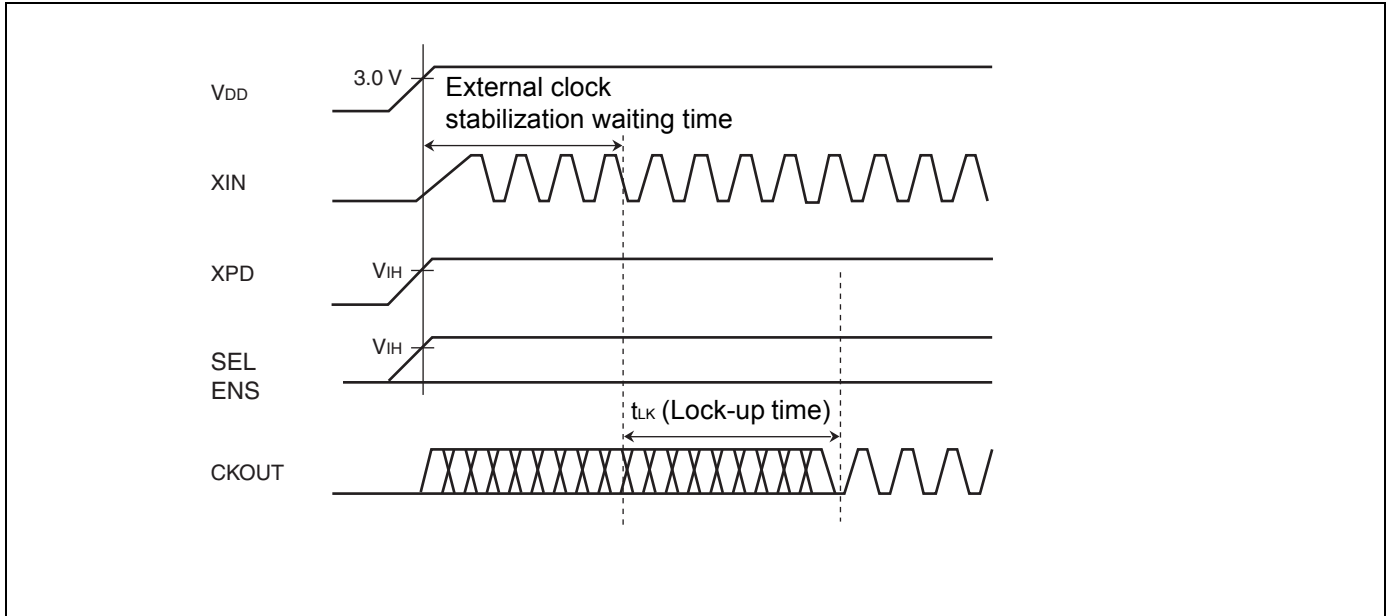
- Modulation rate $\pm 1.0\%$, example of center spread



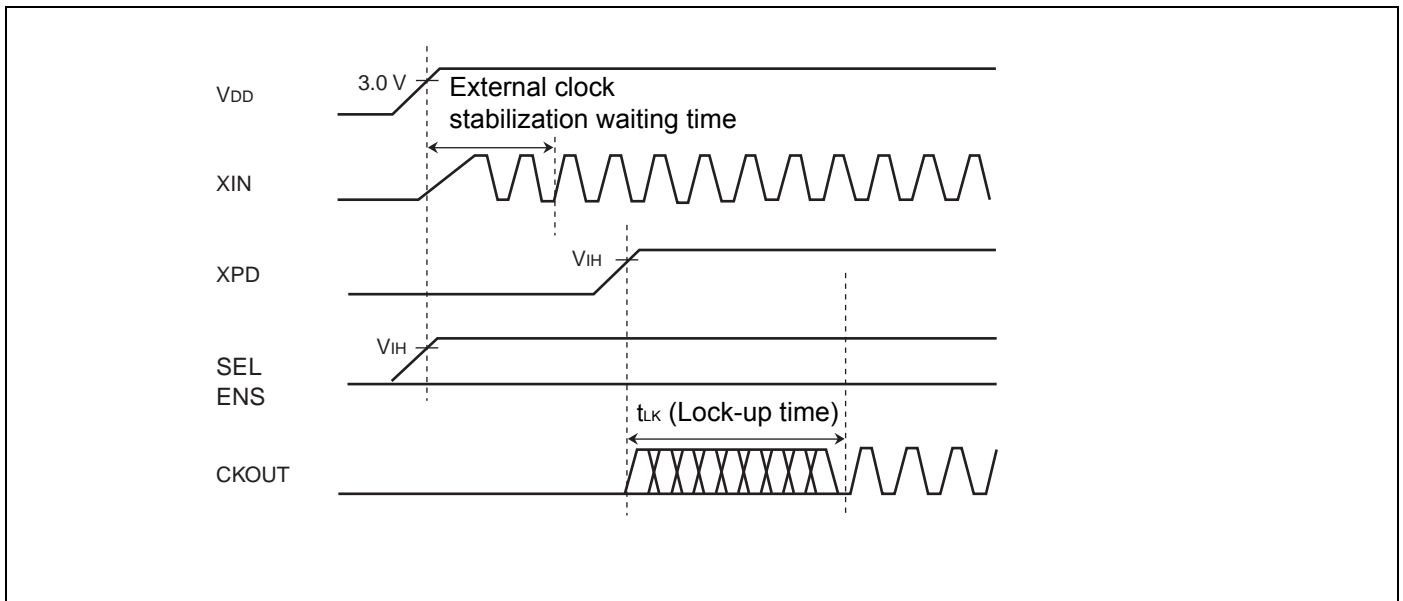
- Modulation rate $- 1.0\%$, example of down spread



16. Lock-Up Time



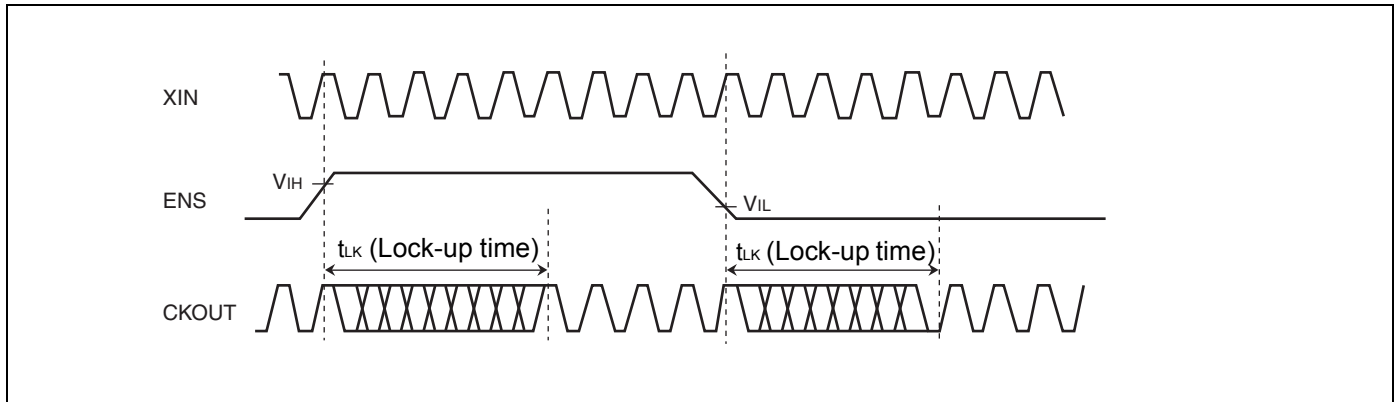
If the XPD pin is fixed at the “H” level, the maximum time after the power is turned on until the set clock signal is output from CKOUT pin is (the stabilization wait time of input clock to XIN pin) + (the lock-up time “t_{LK}”). For the input clock stabilization time, check the characteristics of the resonator or oscillator used.



If the XPD pin is used for power-down control, the set clock signal is output from the CKOUT pin at most the lock-up time “t_{LK}” after the XPD pin goes “H” level.

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If the ENS pin is used for modulation enable control during normal operation, the set clock signal is output from the CKOUT pin at most the lock-up time "t_{LK}" after the level at the ENS pin is determined.

Note : The wait time for the clock signal output from the CKOUT pin to become stable is required after the IC is released from power-down mode by the XPD pin or after another pin's setting is changed. During the period until the output clock signal becomes stable, neither of the output frequency, output clock duty cycle, modulation period, and cycle-cycle jitter characteristic cannot be guaranteed. It is therefore advisable to take action, such as cancelling a device reset at the stage after the lock-up time has passed.

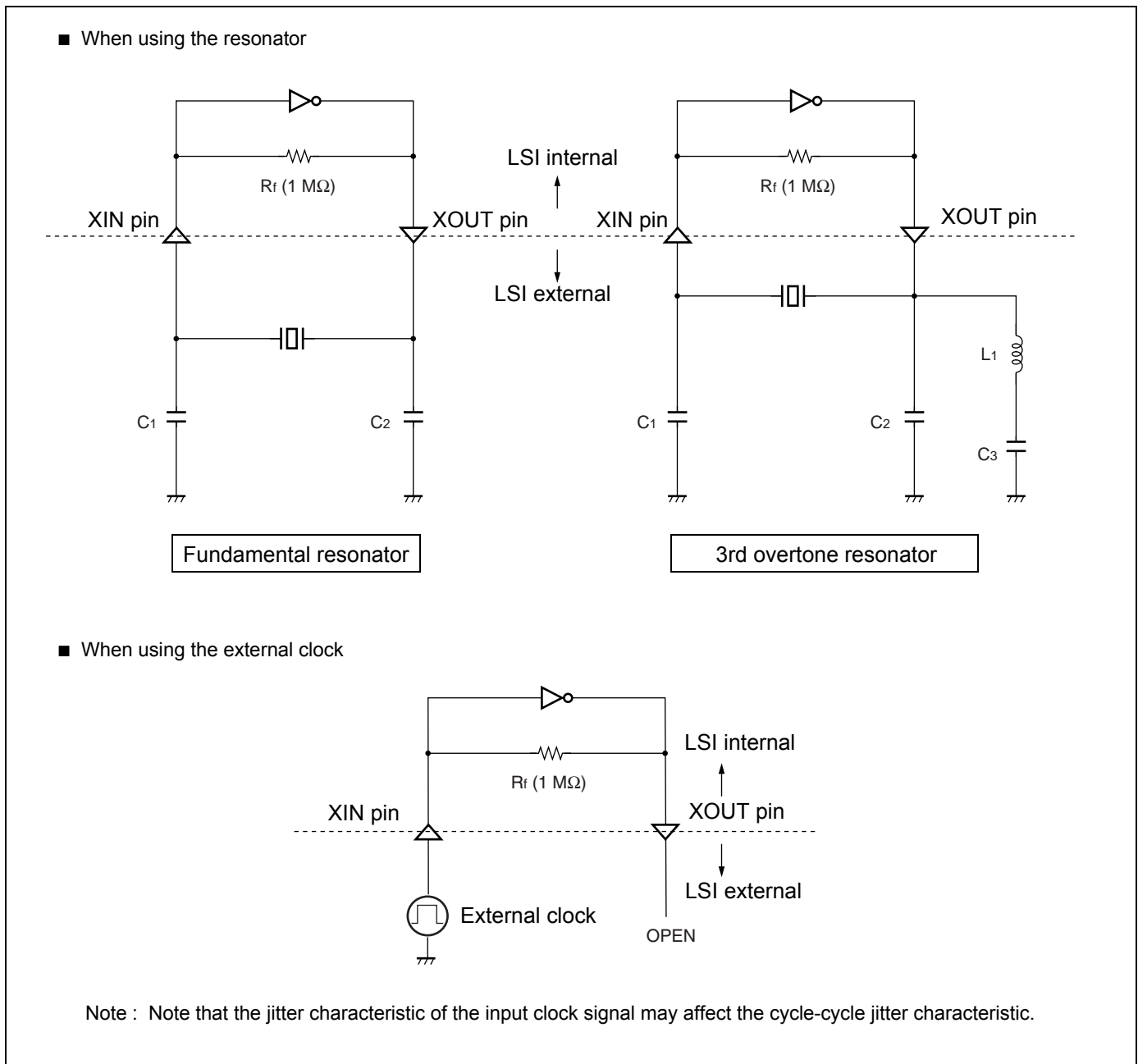
17. Oscillation Circuit

The following schematic on the left-hand side shows a sample connection of a general resonator. The oscillation circuit contains a feedback resistor ($1\text{ M}\Omega$). The values of capacitors (C_1 and C_2) must be adjusted to the optimum constant of the resonator used.

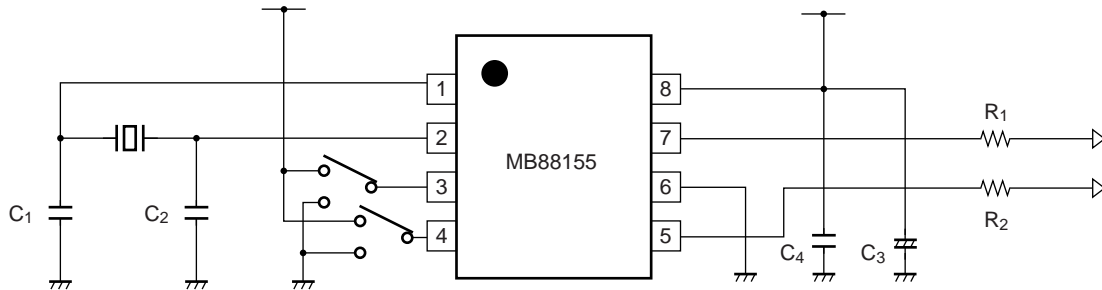
The following schematic on the right-hand side shows a sample connection of a 3rd overtone resonator. The values of capacitors (C_1 , C_2 , and C_3) and inductor (L_1) must be adjusted to the optimum constant of the resonator used.

The most suitable value is different by individual resonator. Please refer to the resonator manufacturer which you use for the most suitable value.

To use an external clock signal (without using the resonator), input the clock signal to the XIN pin with the XOUT pin connected to nothing.



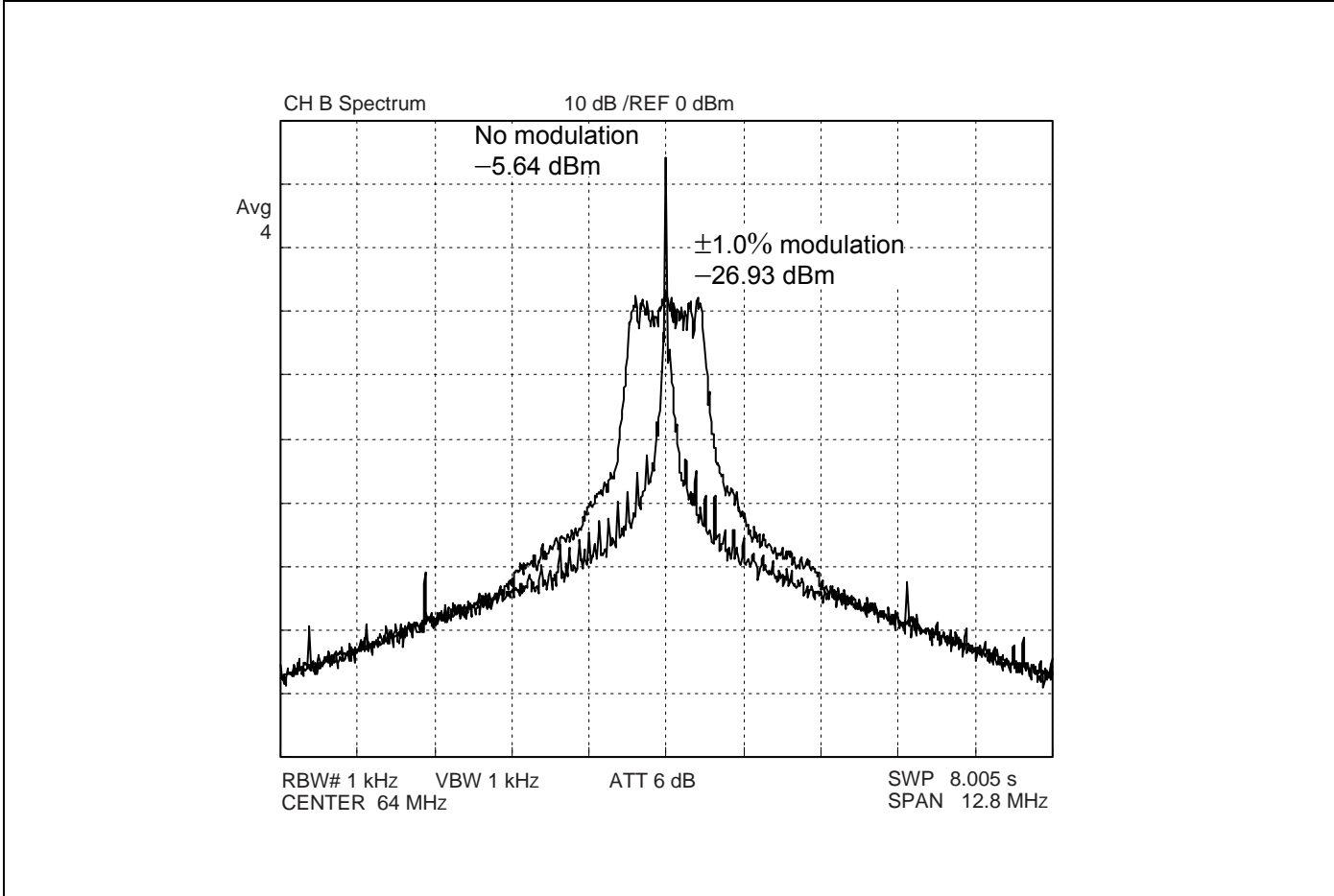
18. Interconnection Circuit Example



- C₁, C₂ : Oscillation stabilization capacitance (refer to "Oscillation Circuit")
- C₃ : Capacitor of 10 μF or higher
- C₄ : Capacitor of about 0.01 μF (connect a capacitor of good high frequency property (ex. laminated ceramic capacitor) to close to this device)
- R₁, R₂ : Impedance matching resistor for board pattern

19. Spectrum Example Characteristics

The condition of the examples of the characteristic is shown as follows : Input frequency = 16 MHz (Output frequency = 64 MHz : Using MB88155-410 (Multiplied by 4))
 Power-supply voltage = 3.3 V, None load capacity. Modulation rate = $\pm 1.0\%$ (center spread).
 Spectrum analyzer HP4396B is connected with CKOUT. The result of the measurement with RBW = 1 kHz (ATT use for -6 dB) .

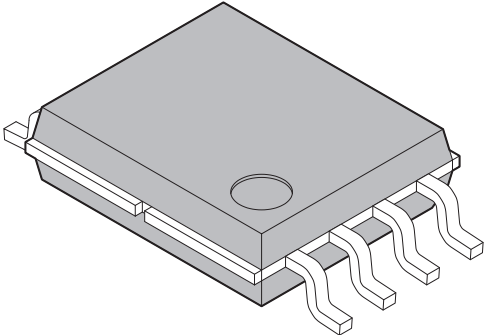


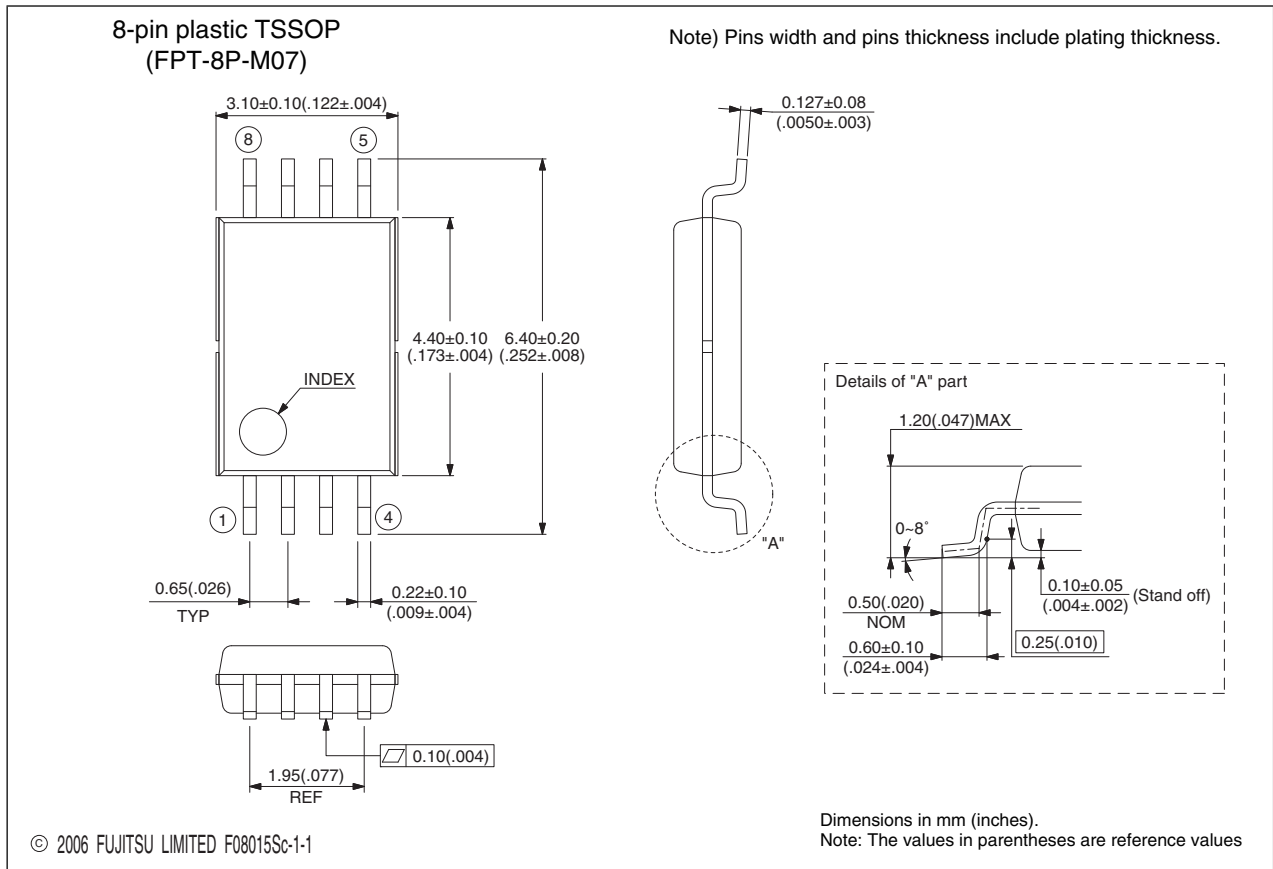
20. Ordering Information

Part number	Input frequency	Multiplication rate	Output frequency	Modulation type	Modulation enable pin	Power down pin	Package	Remarks
MB88155PFT-G-100-JNE1	12.5 MHz to 25 MHz	Multiplied by 1	The same as input frequency	Down spread	Yes	No	8-pin plastic TS-SOP (FPT-8P-M07)	
MB88155PFT-G-101-JNE1	25 MHz to 50 MHz				No	Yes		
MB88155PFT-G-102-JNE1	12.5 MHz to 25 MHz							
MB88155PFT-G-103-JNE1	25 MHz to 50 MHz							
MB88155PFT-G-110-JNE1	12.5 MHz to 25 MHz			Center spread	Yes	No		
MB88155PFT-G-111-JNE1	25 MHz to 50 MHz				No	Yes		
MB88155PFT-G-112-JNE1	12.5 MHz to 25 MHz							
MB88155PFT-G-113-JNE1	25 MHz to 50 MHz							
MB88155PFT-G-400-JNE1	12.5 MHz to 20 MHz	Multiplied by 4	50 MHz to 80 MHz	Down spread	Yes	No		
MB88155PFT-G-402-JNE1					No	Yes		
MB88155PFT-G-410-JNE1				Yes	No			
MB88155PFT-G-412-JNE1						No		
MB88155PFT-G-100-JN-EFE1	12.5 MHz to 25 MHz	Multiplied by 1	The same as input frequency	Down spread	Yes	No	8-pin plastic TS-SOP (FPT-8P-M07)	Emboss taping (EF type)
MB88155PFT-G-101-JN-EFE1	25 MHz to 50 MHz				No	Yes		
MB88155PFT-G-102-JN-EFE1	12.5 MHz to 25 MHz							
MB88155PFT-G-103-JN-EFE1	25 MHz to 50 MHz							

Part number	Input frequency	Multiplication rate	Output frequency	Modulation type	Modulation enable pin	Power down pin	Package	Remarks
MB88155PFT-G-110-JN-EFE1	12.5 MHz to 25 MHz	Multiplied by 1	The same as input frequency	Center spread	Yes	No	8-pin plastic TS-SOP (FPT-8P-M07)	Emboss taping (EF type)
MB88155PFT-G-111-JN-EFE1	25 MHz to 50 MHz							
MB88155PFT-G-112-JN-EFE1	12.5 MHz to 25 MHz				No	Yes		
MB88155PFT-G-113-JN-EFE1	25 MHz to 50 MHz							
MB88155PFT-G-400-JN-EFE1	12.5 MHz to 20 MHz	Multiplied by 4	50 MHz to 80 MHz	Down spread	Yes	No	8-pin plastic TS-SOP (FPT-8P-M07)	Emboss taping (EF type)
MB88155PFT-G-402-JN-EFE1	25 MHz to 50 MHz							
MB88155PFT-G-410-JN-EFE1	12.5 MHz to 25 MHz			Center spread	Yes	No		
MB88155PFT-G-412-JN-EFE1	25 MHz to 50 MHz							
MB88155PFT-G-100-JN-ERE1	12.5 MHz to 25 MHz	Multiplied by 1	The same as input frequency	Down spread	Yes	No	8-pin plastic TS-SOP (FPT-8P-M07)	Emboss taping (ER type)
MB88155PFT-G-101-JN-ERE1	25 MHz to 50 MHz							
MB88155PFT-G-102-JN-ERE1	12.5 MHz to 25 MHz				No	Yes		
MB88155PFT-G-103-JN-ERE1	25 MHz to 50 MHz							
MB88155PFT-G-110-JN-ERE1	12.5 MHz to 25 MHz			Center spread	Yes	No		
MB88155PFT-G-111-JN-ERE1	25 MHz to 50 MHz							
MB88155PFT-G-112-JN-ERE1	12.5 MHz to 25 MHz				No	Yes		
MB88155PFT-G-113-JN-ERE1	25 MHz to 50 MHz							
MB88155PFT-G-400-JN-ERE1	12.5 MHz to 20 MHz	Multiplied by 4	50 MHz to 80 MHz	Down spread	Yes	No	8-pin plastic TS-SOP (FPT-8P-M07)	Emboss taping (ER type)
MB88155PFT-G-402-JN-ERE1	25 MHz to 50 MHz							
MB88155PFT-G-410-JN-ERE1	12.5 MHz to 25 MHz			Center spread	Yes	No		
MB88155PFT-G-412-JN-ERE1	25 MHz to 50 MHz							

21. Package Dimensions

<p style="text-align: center;">8-pin plastic TSSOP</p>  <p style="text-align: center;">(FPT-8P-M07)</p>	Lead pitch	0.65 mm	
	Package width × package length	4.40 mm × 3.10 mm	
	Lead shape	Gullwing	
	Sealing method	Plastic mold	
	Mounting height	1.20 mm Max	



Document History

Spansion Publication Number: DS04-29119-2Ea

Document Title: MB88155 Spread Spectrum Clock Generator Document Number: 002-08298				
Revision	ECN	Orig. of Change	Submission Date	Description of Change
**	–	TAOA	11/09/2006	Initial Release
*A	5568597	TAOA	12/29/2016	Updated to Cypress Template

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